



N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
30	0.034 at V _{GS} = 4.5 V	6.1			
30	0.050 at V _{GS} = 2.5 V	5.0			

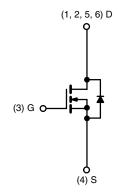
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 2.5 V Rating for 30 V N-Channel
- Low R_{DS(on)} for Footprint Area Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

• Li-Ion Battery Protection



N-Channel MOSFET

		TSOI Top V		
T		1	6	
3 mm	П	2	5	Ш
		3	4	
	 - -	— 2.85 r	nm _	

Ordering Information: Si3434DV-T1-E3 (Lead (Pb)-free)

Si3434DV-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS	$I_A = 25^{\circ}C$, unle	ss offierwise i	ioted			
Parameter		Symbol	5 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	30		V	
Gate-Source Voltage		V _{GS}	± 12		V	
Out in the Date Out of the 150 00\2	T _A = 25 °C	- I _D	6.1	4.6	٨	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		4.9	3.6		
Pulsed Drain Current		I _{DM}	30		Α	
Continuous Source Current (Diode Conduction) ^a		I _S	1.7	1.0		
Maniana Banas Birata di ad	T _A = 25 °C	- P _D	2.0	1.14	W	
Maximum Power Dissipation ^a	T _A = 70 °C] rD	1.3	0.73	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 1	to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	t ≤ 5 s	R _{thJA}	40	62.5	
	Steady State	' ¹thJA	90	110	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	25	30	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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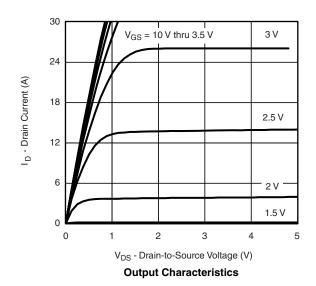
SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 1 \text{ mA}$	0.6			V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 24 V, V _{GS} = 0 V			1		
		V _{DS} = 24 V, V _{GS} = 0 V, T _J = 70 °C			5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	30			Α	
D : 0	D	V _{GS} = 4.5 V, I _D = 6.1 A		0.028	0.034	0	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 2.5 V, I _D = 2 A		0.042	0.050	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 6.1 A		20		S	
Diode Forward Voltage ^a	V_{SD}	I _S = 1.7 A, V _{GS} = 0 V		0.8	1.2	V	
Dynamic ^b							
Total Gate Charge	Q_g			8	12		
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 6.1 \text{ A}$		1.9		nC	
Gate-Drain Charge	Q _{gd}			2.6		1	
Turn-On Delay Time	t _{d(on)}			21	40		
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		45	90		
Turn-Off Delay Time	t _{d(off)}	$t_{d(off)}$ $I_D \cong 1 \text{ A, } V_{GEN} = 4.5 \text{ V, } R_g = 6 \Omega$		40	80	ns	
Fall Time	t _f			30	60		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 1.7 A, dI/dt = 100 A/μs		40	80		

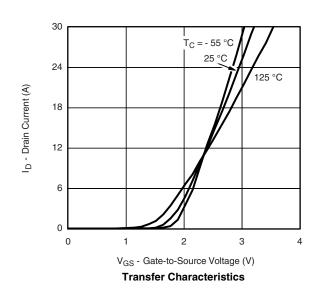
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



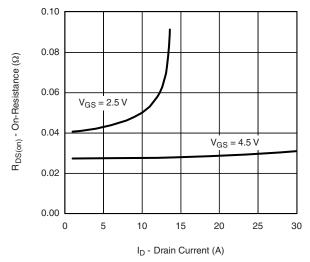




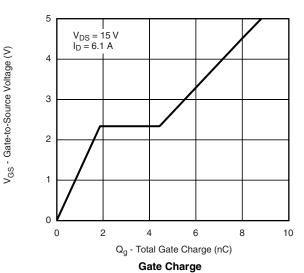


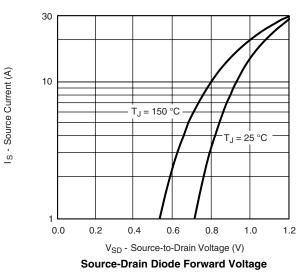


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

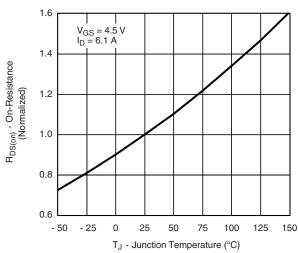


On-Resistance vs. Drain Current

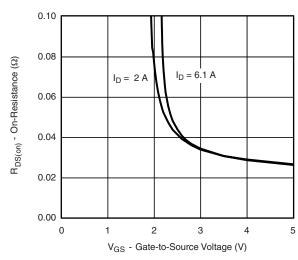




1200 1000 $\mathsf{C}_{\mathsf{iss}}$ C - Capacitance (pF) 800 600 400 Coss 200 0 0 5 10 15 20 25 30



On-Resistance vs. Junction Temperature

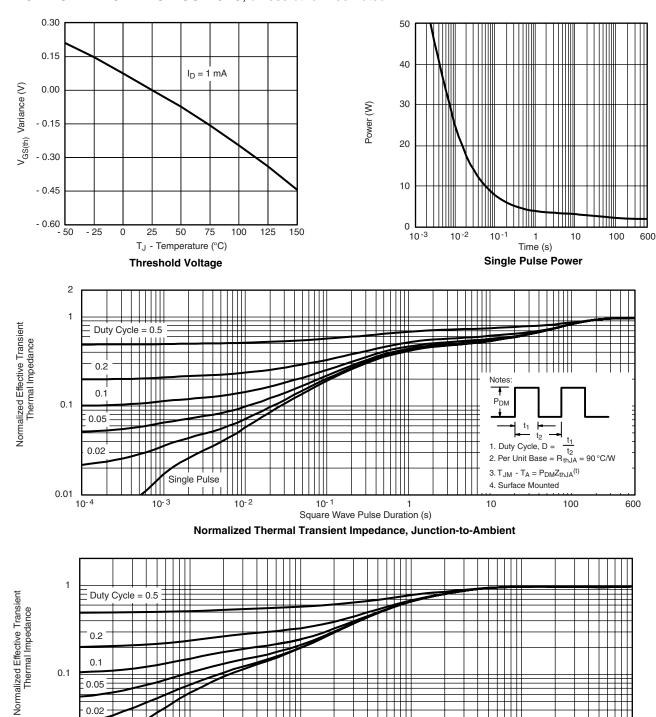


On-Resistance vs. Gate-to-Source Voltage

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Foot

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0.01

Single Pulse

10-3

10



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